

MCH6103/MCH6203

Continued from preceding page.

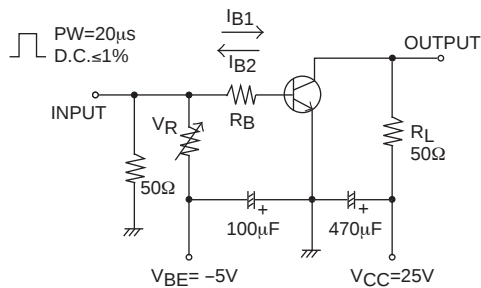
Parameter	Symbol	Conditions	Ratings	Unit
Collector Current	I_C		(-)1.0	A
Collector Current (Pulse)	I_{CP}		(-)3	A
Base Current	I_B		200	mA
Collector Dissipation	P_C	When mounted on ceramic substrate (600mm ² ×0.8mm)	1.0	W
Junction Temperature	T_j		150	°C
Storage Temperature	T_{stg}		-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Electrical Characteristics at $T_a=25^{\circ}\text{C}$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	I_{CBO}	$V_{CB}=(-)40\text{V}$, $I_E=0\text{A}$			(-)0.1	μA
Emitter Cutoff Current	I_{EBO}	$V_{EB}=(-)4\text{V}$, $I_C=0\text{A}$			(-)0.1	μA
DC Current Gain	h_{FE}	$V_{CE}=(-)2\text{V}$, $I_C=(-)100\text{mA}$	200		560	
Gain-Bandwidth Product	f_T	$V_{CE}=(-)10\text{V}$, $I_C=(-)300\text{mA}$		420		MHz
Output Capacitance	C_{ob}	$V_{CB}=(-)10\text{V}$, $f=1\text{MHz}$		(9)6		pF
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)1}$	$I_C=(-)500\text{mA}$, $I_B=(-)10\text{mA}$		(-280)130	(-430)190	mV
	$V_{CE(sat)2}$	$I_C=(-)300\text{mA}$, $I_B=(-)6\text{mA}$		(-145)90	(-220)135	mV
Base-to-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=(-)500\text{mA}$, $I_B=(-)10\text{mA}$		(-)0.81	(-)1.2	V
Collector-to-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C=(-)10\mu\text{A}$, $I_E=0\text{A}$	(-50)80			V
Collector-to-Emitter Breakdown Voltage	$V_{(BR)CES}$	$I_C=(-)100\mu\text{A}$, $R_{BE}=0\Omega$	(-50)80			V
	$V_{(BR)CEO}$	$I_C=(-)1\text{mA}$, $R_{BE}=\infty$	(-)50			V
Emitter-to-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E=(-)10\mu\text{A}$, $I_C=0\text{A}$	(-)5			V
Turn-On Time	t_{on}	See specified Test Circuit.		(36)38		ns
Storage Time	t_{stg}			(173)332		ns
Fall Time	t_f			(28)40		ns

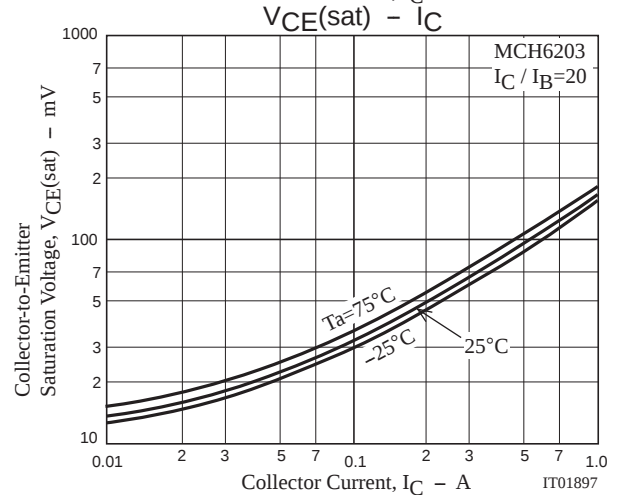
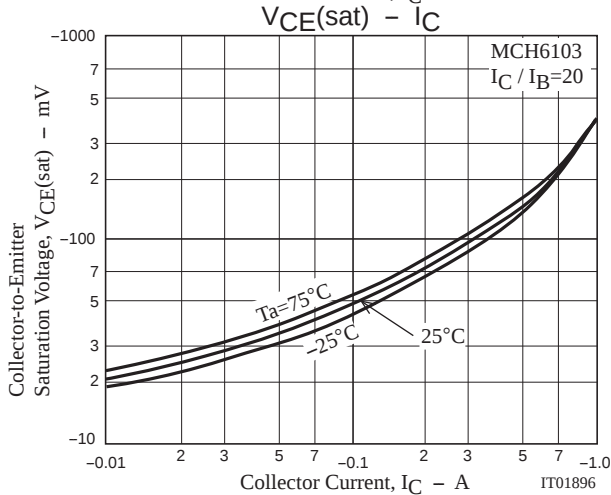
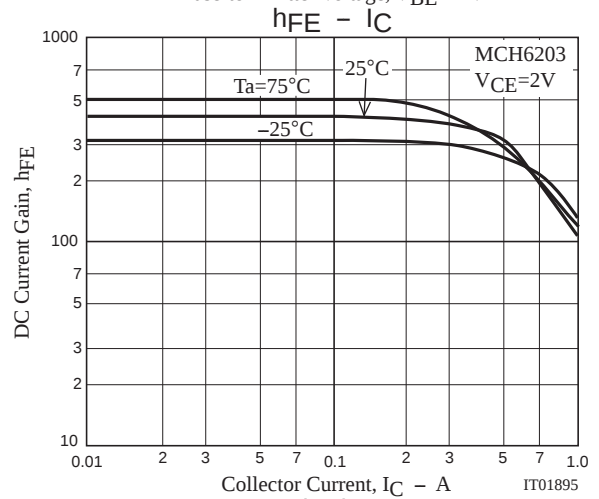
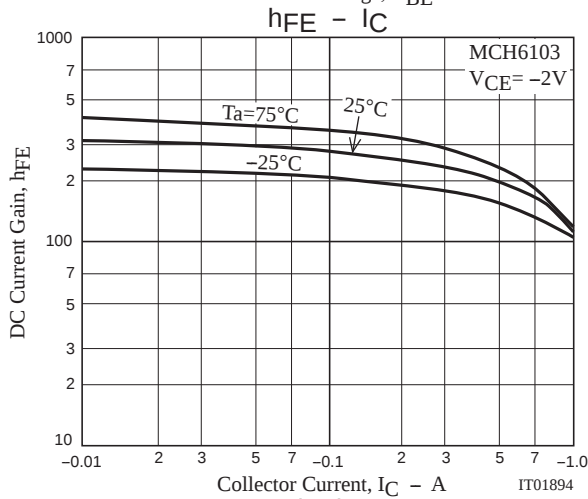
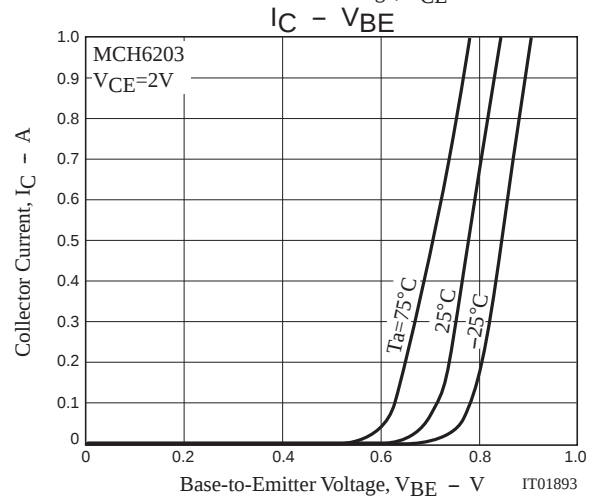
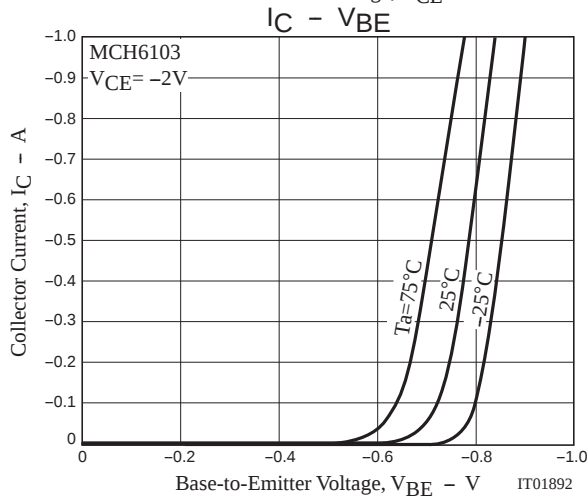
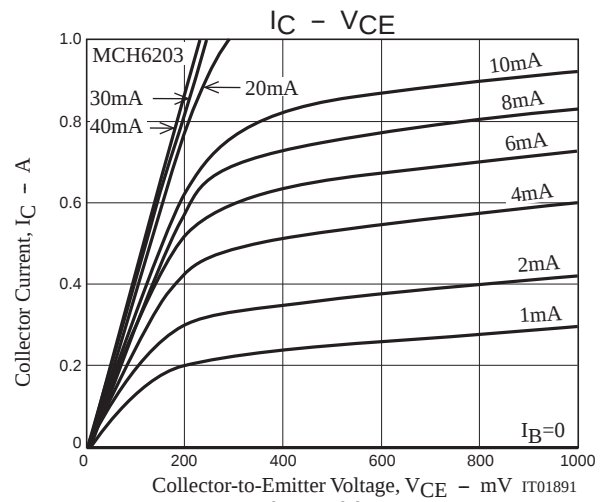
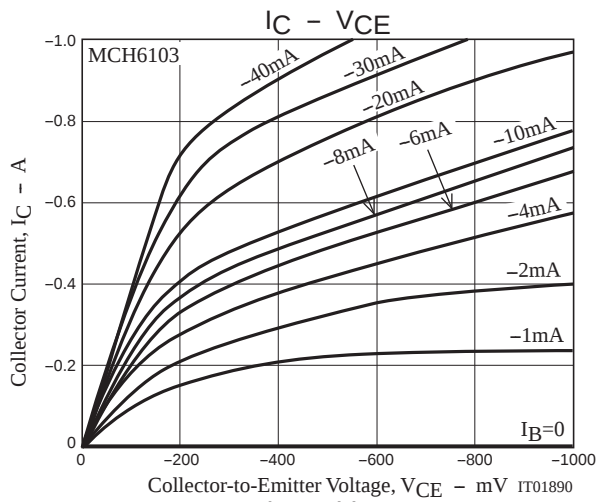
Switching Time Test Circuit

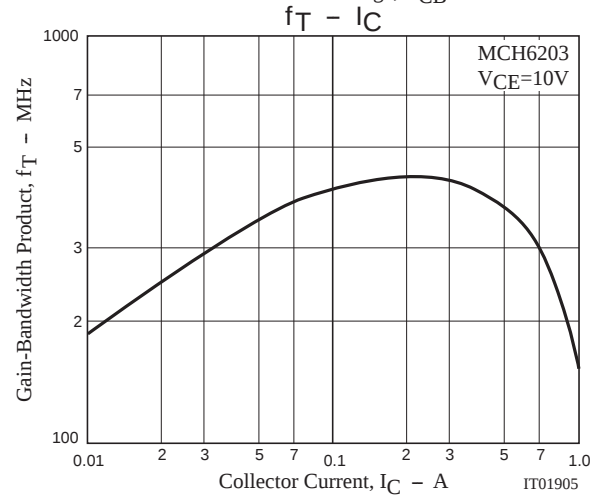
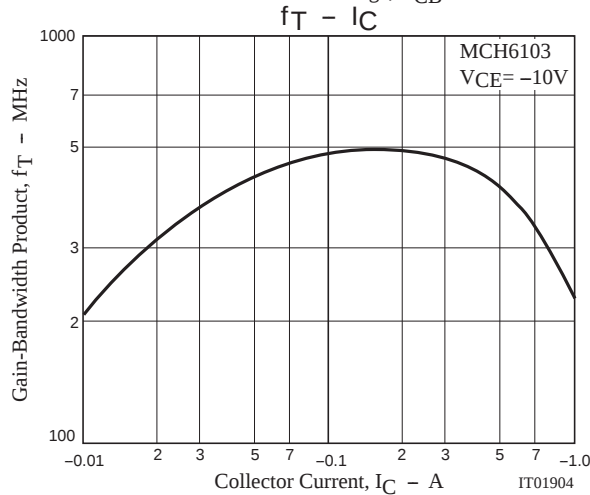
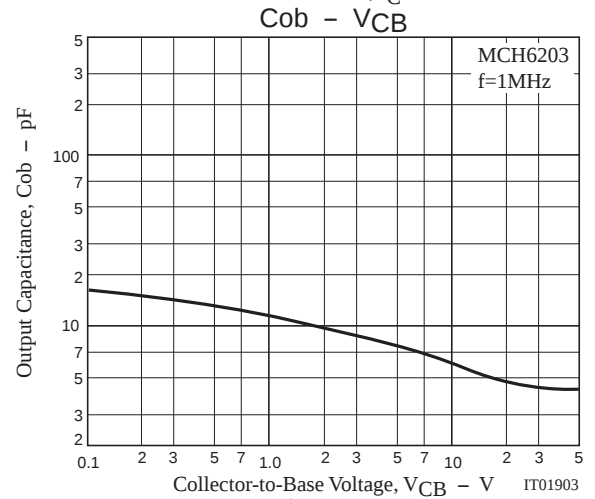
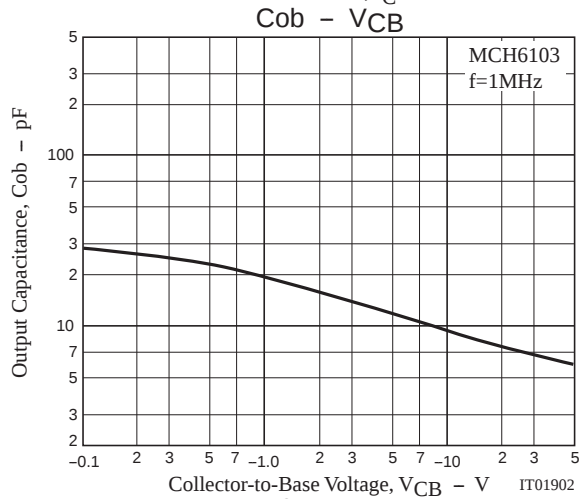
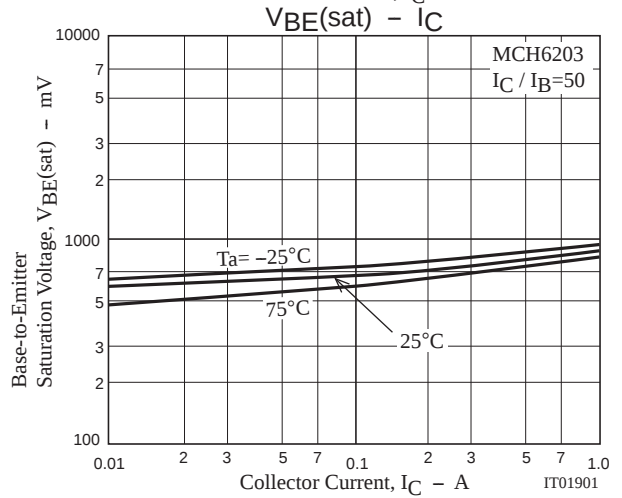
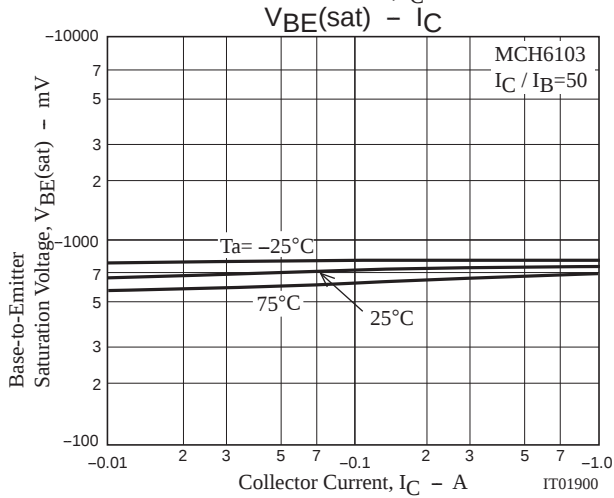
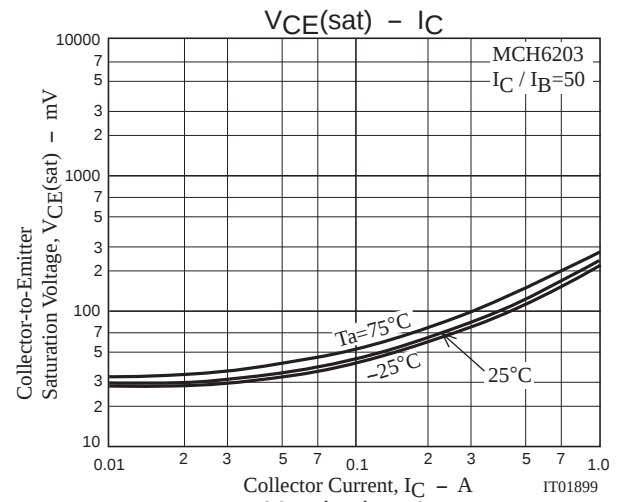
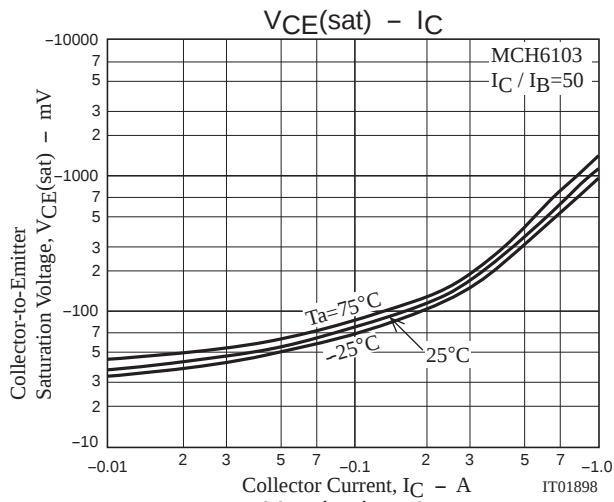


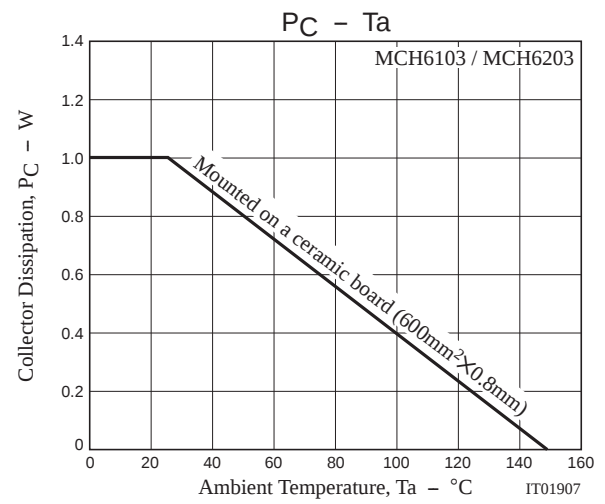
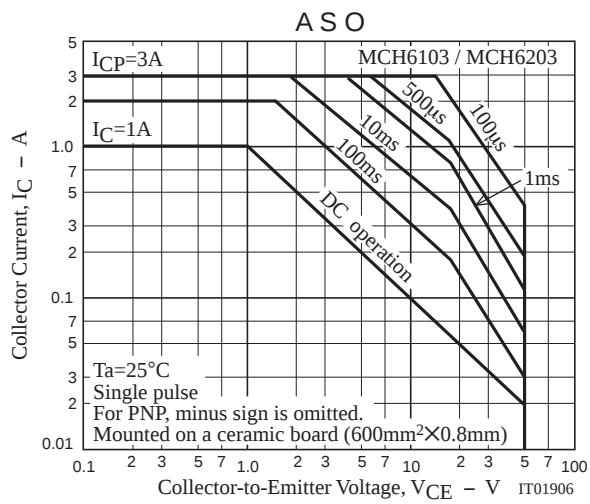
$I_C=20I_{B1}= -20I_{B2}=500\text{mA}$
For PNP, the polarity is reversed.

Ordering Information

Device	Package	Shipping	memo
MCH6103-TL-E	MCPH6	3,000pcs./reel	Pb Free
MCH6203-TL-E	MCPH6	3,000pcs./reel	







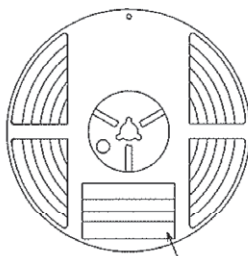
Embossed Taping Specification

MCH6103-TL-E, MCH6203-TL-E

1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
MCPH6	MCP4	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

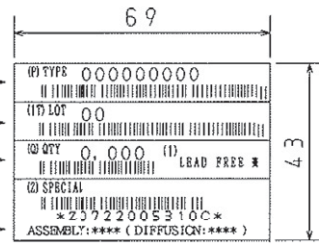
Packing method



Type No.
LOT No.
Quantity
Origin

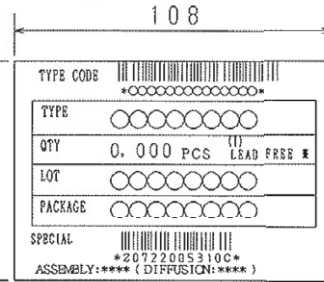
Reel label

Reel label, Inner box label
(unit:mm)



Outer box label

It is a label at the time of factory shipments.
The form of a label may change in physical
distribution process.



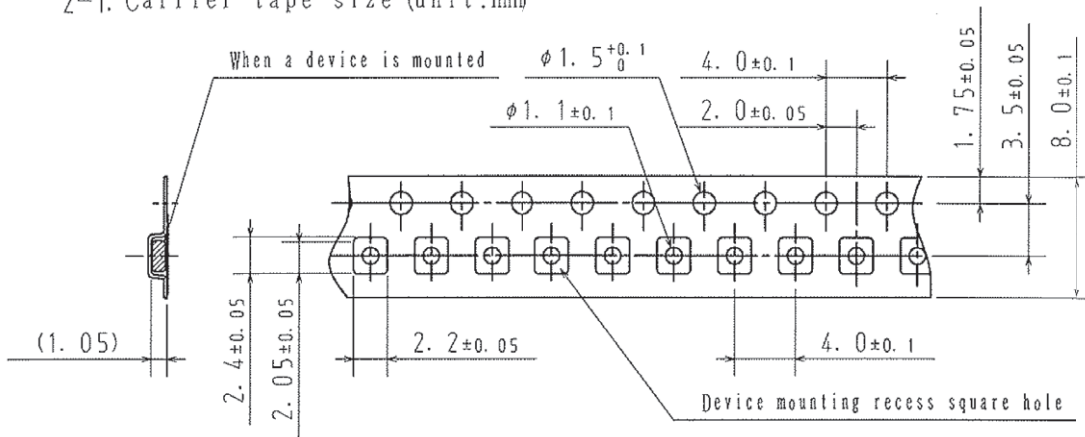
NOTE (1)

The LEAD FREE * description shows that the surface
treatment of the terminal is lead free.

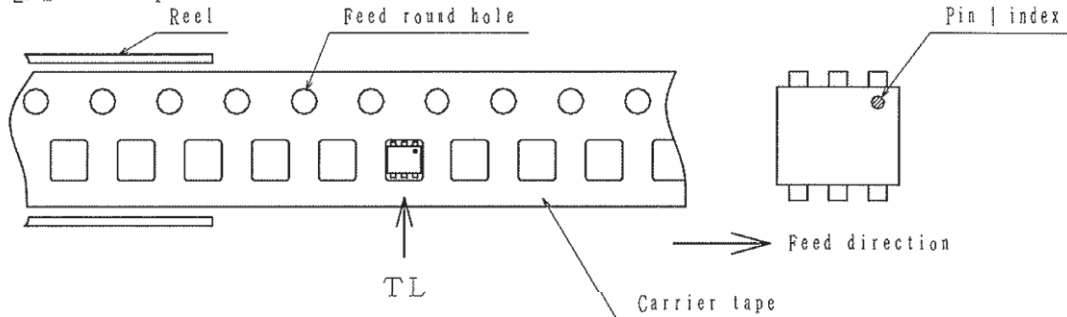
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



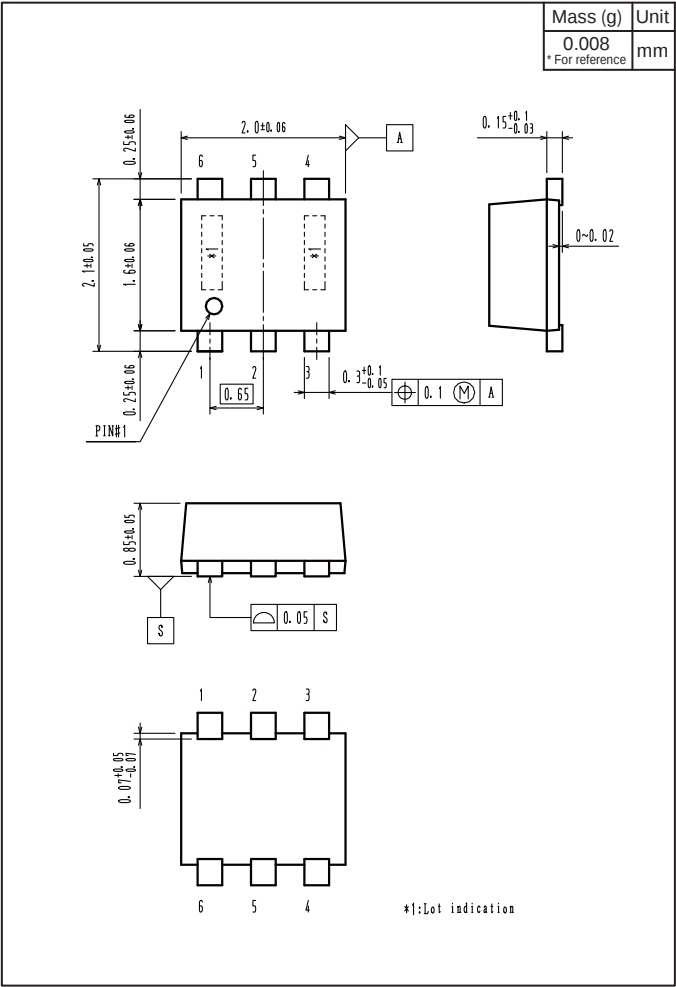
2-2. Device placement direction



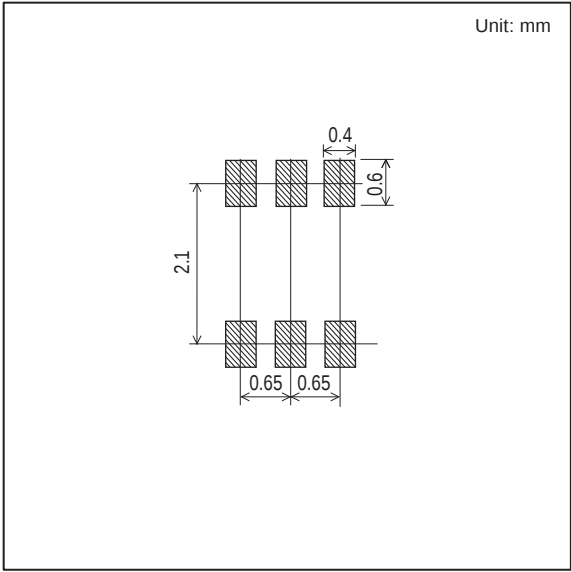
Those with pin 1 index on the feed hole side.....TL

Outline Drawing

MCH6103-TL-E, MCH6203-TL-E



Land Pattern Example



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